

UNITED STATES DEPARTMENT OF COMMERCE

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Washington, D.C. 20231

APPLICATION NO. FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO.

09/392,899

09/09/99

AZCARATE

R

TI-22451

EXAMINER

023494

MMC2/0703

TEXAS INSTRUMENTS INCORPORATED P 0 BOX 655474, M/S 3999 DALLAS TX 75265

CHAMBLISS ARTUNIT

PAPER NUMBER

2814
DATE MAILED:

07/03/01

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

	Application No.	Applicant(s)	
Office Action Summary	09/392,899	AZCARATE ET AL.	
	Examiner	Art Unit	
	Alonzo Chambliss	2814	
The MAILING DATE of this communication Period for Reply	appears on the cover sheet with	the correspondence address	
A SHORTENED STATUTORY PERIOD FOR R THE MAILING DATE OF THIS COMMUNICATI - Extensions of time may be available under the provisions of 37 C after SIX (6) MONTHS from the mailing date of this communication - If the period for reply specified above is less than thirty (30) days, - If NO period for reply is specified above, the maximum statutory properties of the period for reply within the set or extended period for reply will, by - Any reply received by the Office later than three months after the earned patent term adjustment. See 37 CFR 1.704(b). Status	ON. FR 1.136 (a). In no event, however, may a ron. a reply within the statutory minimum of thirt period will apply and will expire SIX (6) MON statute, cause the application to become AB	eply be timely filed y (30) days will be considered timely. THS from the mailing date of this communication. ANDONED (35 U.S.C. § 133).	
1) Responsive to communication(s) filed or	n <u>09 September 1999</u> .		
•	This action is non-final.		
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.			
Disposition of Claims			
4)⊠ Claim(s) <u>1-6</u> is/are pending in the application.			
4a) Of the above claim(s) is/are with	thdrawn from consideration.		
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) <u>1-6</u> is/are rejected.			
7) Claim(s) is/are objected to.			
8) Claims are subject to restriction a	and/or election requirement.		
Application Papers			
9) The specification is objected to by the Ex	aminer.		
10)⊠ The drawing(s) filed on <u>09 September 1999</u> is/are objected to by the Examiner.			
11) The proposed drawing correction filed or			
12) The oath or declaration is objected to by the Examiner.			
Priority under 35 U.S.C. § 119			
13) Acknowledgment is made of a claim for f	foreign priority under 35 U.S.C.	§ 119(a)-(d) or (f).	
a) ☐ All b) ☐ Some * c) ☐ None of:	g., p		
1. Certified copies of the priority doct	uments have been received.		
	The second secon		
3. Copies of the certified copies of the priority documents have been received in this National Stage			
application from the Internation * See the attached detailed Office action for	nal Bureau (PCT Rule 17.2(a)).		
14) Acknowledgement is made of a claim for	r domestic priority under 35 U.S	S.C. § 119(e).	
Attachment(s)			
 15) Notice of References Cited (PTO-892) 16) Notice of Draftsperson's Patent Drawing Review (PTO-17) Information Disclosure Statement(s) (PTO-1449) Pape 	-948) 19) Notice	w Summary (PTO-413) Paper No(s) of Informal Patent Application (PTO-152)	

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DETAILED ACTION

Oath/Declaration

1. The oath or declaration is defective. A new oath or declaration in compliance with 37 CFR 1.67(a) identifying this application by application number and filing date is required. See MPEP §§ 602.01 and 602.02.

The oath or declaration is defective because: the signature of inventor and date was not signed by Philip B. Simon.

Drawings

2. The drawings are objected to as failing to comply with 37 CFR 1.84(p)(5) because they do not include the following reference sign(s) mentioned in the description: leads 20s on page 7, line 2. Also, the following reference sign(s) not mentioned in the description: 10, 12a, and c. Correction is required.

Claim Objections

3. Claims 1 and 5 are objected to because of the following informalities: the phrase "with tape providing "should be changed to – with tape provided on –. Appropriate correction is required.

Claim Rejections - 35 USC § 112

4. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

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- 5. Claims 1-6 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.
- 6. Claims 1 and 5 recites the limitation "the lead frame strap "on lines 4 and 5 respectively. There is insufficient antecedent basis for this limitation in the claim.

Claim Rejections - 35 USC § 102

7. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 8. Claims 1-6, **insofar as some of them can be understood**, rejected under 35 U.S.C. 102(b) as being anticipated by Ootsuki et al. (U.S. 5,652,461).

With respect to Claims 1, 3, and 5, Ootsuki teaches a plurality of lead frame leads 1 distributed around a semiconductor die mount area on the heat slug 4b. The leads 1 extend into the area normally occupied by a lead frame strap. These leads would be lead 1 and 5 in the row of leads that contains five leads in Fig. 2B. A heat slug 4b is attached under the lead frame with a tape 2a on a rectangular die mount area (see Fig. 2B). The same number of lead frame leads 1 on opposites sides of the lead frame and different number of lead frame leads 1 on adjacent sides of the lead frame can be seen in Fig. 2B).

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With respect to Claim 2, the semiconductor die 3 has four sides and the lead frame leads 1 are evenly distributed on each of the four sides (see Fig. 2B).

With respect to Claims 4 and 6, the semiconductor die 3 has a different number of bond pads on adjacent sides and the same number of bond pads on opposite sides, wherein at least one of the bond pads is attached to a bond wire 5. The bond pad is the section on the die where the bond wire 5 is attached to the die 3. The bond wire 5 is attached to a lead frame lead 1 on a side of the lead frame adjacent to the side of the semiconductor die on with the bond pad is located (see Fig. 2B).

Conclusion

9. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. It is cited primarily to show the product of the instant invention.

Any inquiry concerning the communication or earlier communications from the examiner should be directed to Alonzo Chambliss whose telephone number is (703) 306-9143. The fax phone number for this Group is (703) 308-7722 or 7724.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-7956.

> OLIK CHAUDHURI SUPERVISORY PATENT EXAMINER

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AC/June 29, 2001